

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(on)} Max	I _D T _A = +25°C
-20V	0.75Ω @ V _{GS} = -4.5V	-0.99A
	1.05Ω @ V _{GS} = -2.5V	-0.83A

Features and Benefits

- 0.6mm² Footprint—Thirteen Times Smaller than SOT23
- Low Gate Threshold Voltage
- Fast Switching Speed
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP2900UFBQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(on)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Load Switch

Mechanical Data

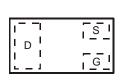
- Package: X1-DFN1006-3
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.001 grams (Approximate)



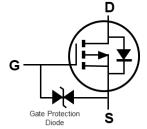




Bottom View



Top View Internal Schematic



Equivalent Circuit

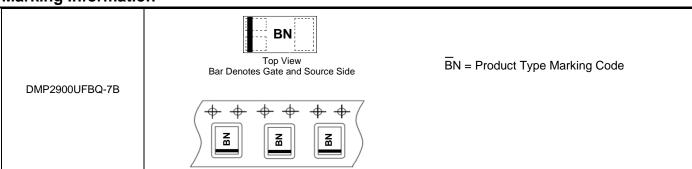
Ordering Information (Note 4)

Part Number	Package	Packing	
DMP2900UFBQ-7B	X1-DFN1006-3	10,000	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.</p>
 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±6	V
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady	T _A = +25°C		-0.99	А
Continuous Diain Current (Note 6) VGS = 4.5V	State	$T_A = +70^{\circ}C$	ID	-0.79	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-2.6	Α

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	0.55	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{OJA}	229	°C/W
Total Power Dissipation (Note 6)	P _D	1.11	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	113	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

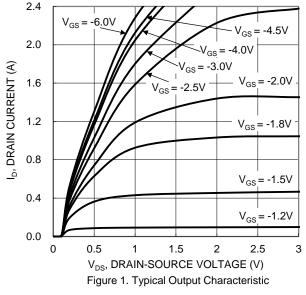
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

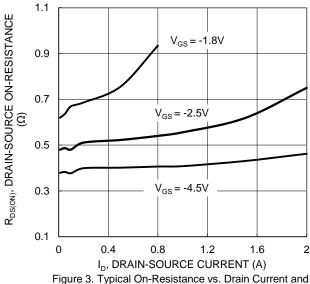
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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	-100	nA	$V_{DS} = -20V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±2.0	μA	$V_{GS} = \pm 4.5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	-0.5		-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
		1	0.4	0.75	Ω	$V_{GS} = -4.5V, I_D = -430mA$	
Static Drain-Source On-Resistance	R _{DS(on)}		0.5	1.05		$V_{GS} = -2.5V, I_D = -300mA$	
			0.67	1.5		$V_{GS} = -1.8V, I_D = -150mA$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	C _{iss}		49	_	pF	V _{DS} = -16V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	C _{oss}		12		pF		
Reverse Transfer Capacitance	C _{rss}	_	3.4	_	pF		
Total Gate Charge	Qg	_	0.7	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_{D} = -250$ mA	
Gate-Source Charge	Q _{gs}	_	0.1	_	nC		
Gate-Drain Charge	Q _{gd}	_	0.1	_	nC		
Turn-On Delay Time	t _{D(on)}		16	_	ns	$V_{DS} = -10V$, $V_{GS} = -4.5V$, $R_g = 10\Omega$, $R_L = 47\Omega$ $I_D = -200$ mA	
Turn-On Rise Time	t _R	_	15	_	ns		
Turn-Off Delay Time	t _{D(off)}	_	213	_	ns		
Turn-Off Fall Time	t _F	_	89	_	ns		

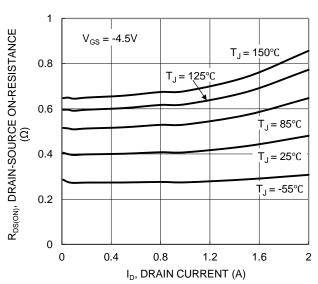
Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm × 25mm square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.



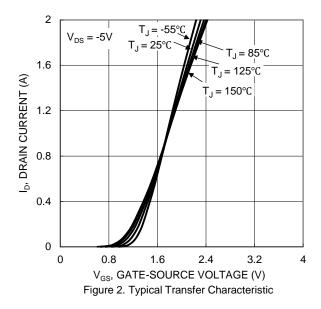


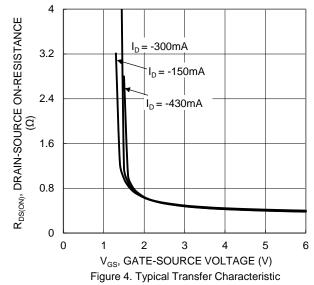




Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Temperature





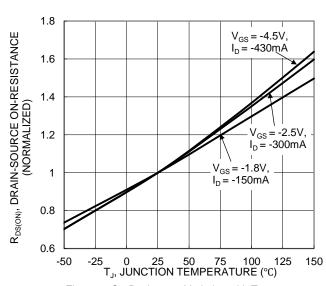


Figure 6. On-Resistance Variation with Temperature



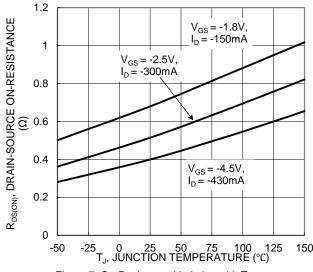
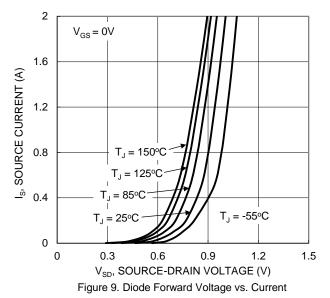


Figure 7. On-Resistance Variation with Temperature



5 4 \$\frac{\gamma}{\sigma}\$ 3 \$\frac{\sigma}{\sigma}\$ 2 1

 ${\rm Q_g}\,({\rm nC})$ Figure 11. Gate Charge

1.5

2

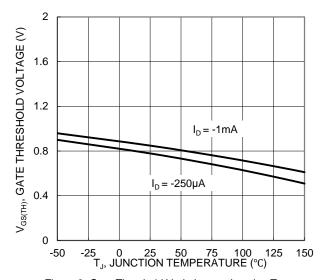


Figure 8. Gate Threshold Variation vs. Junction Temperature

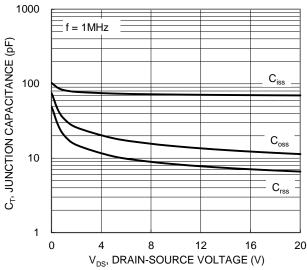
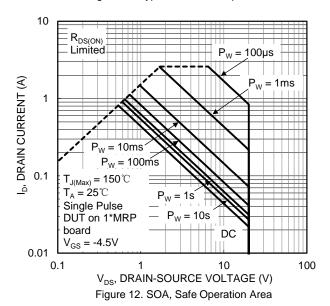


Figure 10. Typical Junction Capacitance



0

0.5

6

2.5



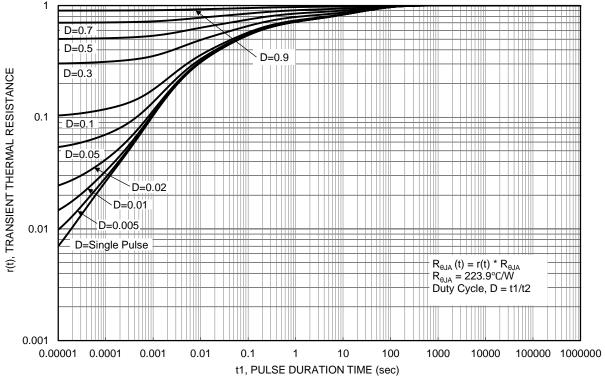


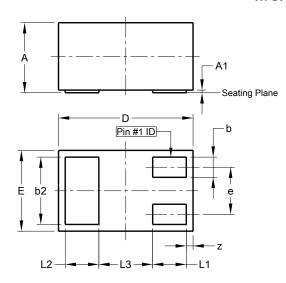
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-3

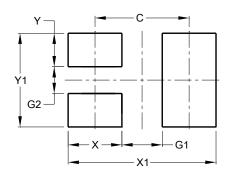


X1-DFN1006-3					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	1	1	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3	-	-	0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-3



Dimensions	Value (in mm)		
С	0.70		
G1	0.30		
G2	0.20		
Х	0.40		
X1	1.10		
Y	0.25		
Y1	0.70		



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